	Туре	L #	Hits	Search Text	DBs
1	BRS	L1	0	·	US- PGPUB; USPAT; EPO; JPO; DERWEN T; IBM_TD B
2	BRS	L2	0		US- PGPUB; USPAT; EPO; JPO; DERWEN: T; IBM_TD B
3	BRS	L4	8		US- PGPUB; USPAT; EPO; JPO; DERWEN T; IBM_TD B
4	BRS	L3	55	allen near ernest.in.	US- PGPUB; USPAT; EPO; JPO; DERWEN T; IBM_TD B

	Туре	L #	Hits	Search Text	DBs
5	BRS	L5	0	looi near miaw.in.	US- PGPUB; USPAT; EPO; JPO; DERWEN T; IBM_TD B
6	BRS	L6	6106	(wafer or substrate) near25 (test) near25 (dies or chips)	US- PGPUB; USPAT; EPO; JPO; DERWEN T; IBM_TD B
7	BRS	L7	25	(wafer or substrate) near25 (test) near25 (dies or chips) near25 (probe near tips)	US- PGPUB; USPAT; EPO; JPO; DERWEN T; IBM_TD B
8	BRS	L8	4	(wafer or substrate) near25 (test) near25 (street or scribe\$1) near25 (probe near tips)	US- PGPUB; USPAT; EPO; JPO; DERWEN T; IBM_TD B

	Туре	L #	Hits	Search Text	DBs
9	BRS	L9	5	· · · · · · · · · · · · · · · · · · ·	US- PGPUB; USPAT; EPO; JPO; DERWEN T; IBM_TD B
10	BRS	L10	165	,	US- PGPUB; USPAT; EPO; JPO; DERWEN T; IBM_TD B
11	BRS	L11	53	(wafer or substrate) near25 (street or scribe\$1) near25 (probe) near10 (pad\$1)	US- PGPUB; USPAT; EPO; JPO; DERWEN T; IBM_TD B
12	BRS	L12	1	(wafer or substrate) near25 (street or scribe\$1) near25 (probe) near10 (pad\$1) near25 (cell or identif\$4)	US- PGPUB; USPAT; EPO; JPO; DERWEN T; IBM_TD B

,	Туре	L#	Hits	Search Text	DBs
13	BRS	L13	5	(street or substrate) near25 (street or scribe\$1) near25 (probe) near25 (cell or identif\$4)	US- PGPUB; USPAT; EPO; JPO; DERWEN T; IBM_TD B
14	BRS	L14	3	"6714031".pn.	US- PGPUB; USPAT; EPO; JPO; DERWEN T; IBM_TD B
15	BRS	L15	1	(identification near nuber)	US- PGPUB; USPAT; EPO; JPO; DERWEN T; IBM_TD B
16	BRS	L16	59113		US- PGPUB; USPAT; EPO; JPO; DERWEN T; IBM_TD B

	Туре	L#	Hits	Search Text	DBs
17	BRS	L17.	12	(identification near number) near15 (wafer oe substrate) near15 (street\$1 ot scribe\$1)	US- PGPUB; USPAT; EPO; JPO; DERWEN T; IBM_TD B
18	BRS	L18	81	(identification) near15 (wafer oe substrate) near15 (street\$1 ot scribe\$1)	DERWEN T; IBM_TD B
19	BRS	L19	0	<pre>(pad\$1) near15 (identification) near15 (wafer oe substrate) near15 (street\$1 ot scribe\$1)</pre>	US- PGPUB; USPAT; EPO; JPO; DERWEN T; IBM_TD B
20	BRS	L20	16	(pad\$1) near15 (cell) near15 (wafer oe substrate) near15 (street\$1 ot scribe\$1)	US- PGPUB; USPAT; EPO; JPO; DERWEN T; IBM_TD B

	Туре	L #	Hits	Search Text	DBs
21	BRS	L21	0	(metal\$3 near pad\$1) near15 (cell) near15 (wafer oe substrate) near15 (street\$1 ot scribe\$1)	US- PGPUB; USPAT; EPO; JPO; DERWEN T; IBM_TD B
22	BRS	L22	6	(metal\$3 near pad\$1) near15 (wafer oe substrate) near15 (street\$1 ot scribe\$1)	1
23	BRS	L23	144	(pad\$1) near15 (wafer oe substrate) near15 (street\$1 ot scribe\$1) and (identification or cell)	US- PGPUB; USPAT; EPO; JPO; DERWEN T; IBM_TD B
24	BRS	L24	139	(pad\$1) near15 (wafer or substrate) near15 (street\$1 ot scribe\$1) and (identification or cell)	US- PGPUB; USPAT; EPO; JPO; DERWEN T; IBM_TD B

	Туре	L #	Hits	Search Text	DBs
25	BRS	L25	1	(pad\$1) near15 (wafer or substrate) near15 (street\$1 ot scribe\$1) and (identification near cell)	US- PGPUB; USPAT; EPO; JPO; DERWEN T; IBM_TD B
26	BRS	L26	44853	(second near5 pad\$1)	US- PGPUB; USPAT; EPO; JPO; DERWEN T; IBM_TD B
27	BRS	L27	3	(second near5 pad\$1) near25 (in) near10 (scribe or street)	US- PGPUB; USPAT; EPO; JPO; DERWEN T; IBM_TD B
28	BRS	L28	40	(pad\$1) near5 (in) near10 (scribe or street)	US- PGPUB; USPAT; EPO; JPO; DERWEN T; IBM_TD B

	Туре	L#	Hits	Search Text	DBs
29	BRS	L29	0	((pad\$1) near15 (in) near30 (scribe or street)) near25 (cell or identif\$4)	US- PGPUB; USPAT; EPO; JPO; DERWEN T; IBM_TD B
30	BRS	L30	54	((pad\$1) near15 (in) near30 (scribe or street)) and (cell or identif\$4)	US- PGPUB; USPAT; EPO; JPO; DERWEN T; IBM_TD B
31	BRS	L31	3	((pad\$1) near15 (in) near30 (scribe or street)) and (cell near5 identif\$4)	US- PGPUB; USPAT; EPO; JPO; DERWEN T; IBM_TD B
32	BRS	L32	5	<pre>((pad\$1) near15 (in) near30 (scribe or street)) and (cell or identif\$4) near25 (metal\$4)</pre>	US- PGPUB; USPAT; EPO; JPO; DERWEN T; IBM_TD B

	Туре	L #	Hits	Search Text	DBs
33	BRS	L33	5	(((pad\$1) near15 (in) near30 (scribe or street)) near25 (current or volage)) and (cell or identif\$4)	US- PGPUB; USPAT; EPO; JPO; DERWEN T; IBM_TD B
34	BRS	L34	31	(((pad\$1) near15 (in) near30 (scribe or street)) and (current or volage)) and (cell or identif\$4)	US- PGPUB; USPAT; EPO; JPO; DERWEN T; IBM_TD B
35	BRS	L35	14	(cell near identification) near15 (chips or dies)	US- PGPUB; USPAT; EPO; JPO; DERWEN T; IBM_TD B
36	BRS	L36	34533	(cell or identification) near15 (chips or dies)	US- PGPUB; USPAT; EPO; JPO; DERWEN T; IBM_TD B

	Туре	L#	Hits	Search Text	DBs
37	BRS	L37	3142	((cell or identif\$4) near15 (chips or dies)) near25 (output)	US- PGPUB; USPAT; EPO; JPO; DERWEN T; IBM_TD B
38	BRS	L38	2976	((cell or identif\$4) near15 (chips or dies)) near15 (output)	US- PGPUB; USPAT; EPO; JPO; DERWEN T; IBM_TD B
39	BRS	L40	6	((cell or identif\$4) near15 (chips or dies)) near15 (output) near15 (test) near15 (contact)	US- PGPUB; USPAT; EPO; JPO; DERWEN T; IBM_TD B
40	BRS	L41	22	((cell or identif\$4) near15 (chips or dies)) near15 (output) near15 (test) near15 (current or voltage)	US- PGPUB; USPAT; EPO; JPO; DERWEN T; IBM_TD B

	Туре	L #	Hits	Search Text	DBs
41	BRS	L39	198	((cell or identif\$4) near15 (chips or dies)) near15	US- PGPUB; USPAT; EPO; JPO; DERWEN T; IBM_TD B

	U	1	1	Document ID	Title
1			US A1	20020095633	Electronic component, a test configuration and a method for testing connections of electronic components on a printed circuit board
2			US A1	20020049927	SEMICONDUCTOR INTEGRATED CIRCUIT
3	·		US	6487682 B2	Semiconductor integrated circuit
4			US	4768195 A	Chip tester
5			US	4183460 A	In-situ test and diagnostic circuitry and method for CML chips
6			RU	2116687 C	Device for testing electrostatic discharges